

Title (en)

HEAT THICKENING COMPOSITION FOR COATING BATHS BASED ON A COPOLYMER HAVING A LOW CRITICAL SOLUBILITY TEMPERATURE

Title (de)

WÄRMEVERDICKENDE ZUSAMMENSETZUNG FÜR BESCHICHTUNGSBÄDER BASIEREND AUF EINEM COPOLYMER MIT EINER NIEDRIGEN KRITISCHEN LÖSLICHKEITSTEMPERATUR

Title (fr)

COMPOSITION THERMOEPAISSISSANTE POUR BAINS DE COUCHAGE A BASE D'UN COPOLYMERE POSSEDANT UNE TEMPERATURE CRITIQUE INFERIEURE DE SOLUBILITE

Publication

**EP 1095079 A1 20010502 (FR)**

Application

**EP 99957638 A 19990624**

Priority

- FR 9901525 W 19990624
- FR 9808171 A 19980626

Abstract (en)

[origin: FR2780422A1] Heat thickening composition for coating baths comprises at least a heat-sensitive copolymer with a comb structure, consisting of a polymeric 'skeleton' segment, on which are grafted at least two lateral polymeric segments, identical or different, with either the skeleton or lateral segments having a low critical solubility temperature (LCST) = 30-80 deg C. An Independent claim is also included for use of said composition in coating bath for paper or cardboard.

IPC 1-7

**C08F 287/00**; C09D 151/00; C08F 291/00; D21H 19/60

IPC 8 full level

**C08F 287/00** (2006.01); **C08F 290/06** (2006.01); **C08F 291/00** (2006.01); **C09D 151/00** (2006.01); **D21H 19/56** (2006.01); **D21H 19/58** (2006.01); **D21H 19/62** (2006.01)

CPC (source: EP)

**C08F 290/062** (2013.01); **D21H 19/58** (2013.01); **D21H 19/62** (2013.01)

Citation (search report)

See references of WO 0000528A1

Designated contracting state (EPC)

AT BE CH DE DK ES FI FR GB GR IE IT LI LU NL PT SE

DOCDB simple family (publication)

**FR 2780422 A1 19991231**; **FR 2780422 B1 20000908**; AU 4271899 A 20000117; BR 9911567 A 20010320; CN 1312830 A 20010912; EP 1095079 A1 20010502; ID 27557 A 20010412; JP 2003522210 A 20030722; WO 0000528 A1 20000106

DOCDB simple family (application)

**FR 9808171 A 19980626**; AU 4271899 A 19990624; BR 9911567 A 19990624; CN 99809433 A 19990624; EP 99957638 A 19990624; FR 9901525 W 19990624; ID 20010036 A 19990624; JP 2000557288 A 19990624